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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: : Wilbur G. Catabay and Wei-Jen Hsia
Appl. No. : 09/884,736
Filed: : June 19, 2001
Title : PLASMA TREATMENT OF LOW DIELECTRIC CONSTANT DIELECTRIC MATERIAL TO FORM STRUCTURES USEFUL IN FORMATION OF METAL INTERCONNECTS AND/OR FILLED VIAS FOR INTEGRATED CIRCUIT STRUCTURE
Grp./ A.U. : 2829
Examiner : Lisa A. Kilday
Docket No. : 00-654/RCE

RECEIVED
APR 29 2003
TECHNOLOGY CENTER 2800

PRELIMINARY AMENDMENT

Honorable Commissioner for Patents
Washington, D.C. 20231

Date: April 24, 2003

Sir:

Please amend the accompanying RCE application as follows: